EDB10XS SERIES

SUPER FAST SURFACE MOUNT SILICON BRIDGE RECTIFIER

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EDB101S THRU EDB106S

SINGLE-PHASE GLASS PASSIVATED SUPER FAST SURFACE MOUNT SILICON BRIDGE RECTIFIER





REVERSE VOLTAGE: 50 to 400 VOLTS FORWARD CURRENT: 1.0 AMPERE

FEATURES

- · Glass passivated chip junction
- · Superfast recovery times for high efficiency
- · High surge overload rating of 50 Amperes peak
- · Ideal for printed circuit board
- \cdot High temperature soldering guaranteed:

260°C for 10 seconds

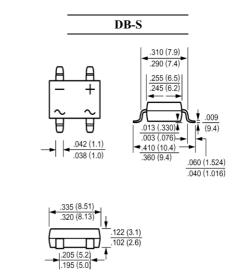
MECHANICAL DATA

Case: Molded plastic, DB-S

Epoxy: UL 94V-O rate flame retardant

Terminals: Leads solderable per MIL-STD-202,

method 208 guaranteed Mounting position: Any Weight: 0.02ounce, 0.4gram



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at 25 ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	EDB101S	EDB102S	EDB103S	EDB104S	EDB105S	EDB106S	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	150	200	300	400	Volts
Maximum RMS Voltage	V _{RMS}	35	70	105	140	210	280	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	150	200	300	400	Volts
Maximum Average Forward	I _(AV) 1.0						•	Amp
Rectified Current at T _A =40	I _(AV)	1.0						
Peak Forward Surge Current,								
8.3ms single half-sine-wave	I _{FSM} 50							Amp
superimposed on rated load (JEDEC method)								
Maximum Forward Voltage at 1.0A DC and 25	$V_{\rm F}$	1.05 1.25					Volts	
Maximum Reverse Current at T _A =25	ı	5.0						uAmp
at Rated DC Blocking Voltage T _A =125	I _R 1000							
Typical Junction Capacitance (Note 1)	$C_{\mathbf{J}}$	15						pF
Maximum Reverse Recovery Time (Note 3)	T_{RR}	50						nS
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	38						/W
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$	12						/W
Operating and Storage Temperature Range	T _J , Tstg	-55 to +150						

NOTES:

- 1- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- 2- Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.5 x 0.5" (13 x 13mm) copper pads
- 3- Reverse Recovery Test Conditions: $I_F \!\!=\! .5A$, $I_R \!\!=\! 1A$, $I_{RR} \!\!=\! .25A.$



RATINGS AND CHARACTERISTIC CURVES

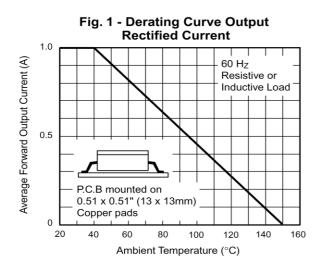


Fig. 2 - Maximum Non-Repetitive Peak **Forward Surge Current** 60 T_J = 150°C Peak Forward Surge Current (A) 50 Single Sine-Wave (JEDEC Method) 40 30 20 10 0 10 100 Number of Cycles at 60 Hz

Fig. 3 - Typical Forward Characteristics Per Leg

10

0.1

T_J = 25° C
Pulse width = 300μ s
1% Duty Cycle

10.01

0.01

0.04

0.6

0.8

1.0

1.2

1.4

Instantaneous Forward Voltage (V)

